

3-Cell, High-Efficiency, Step-Up DC/DC Converter

■ FEATURES

- 4V to 24V Input Voltage Operation.
- Adjustable Output Voltage.
- Low Quiescent Current at 100 μ A.
- Pulse-Skipping and Pulse-Frequency Modulation Maintain High Efficiency (max. 95%).
- 90KHz to 250KHz Oscillator Frequency.
- Power-Saving Shutdown Mode (8 μ A Typical).
- Push-Pull Driver Output.

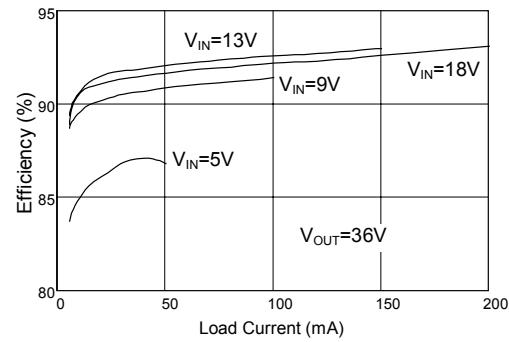
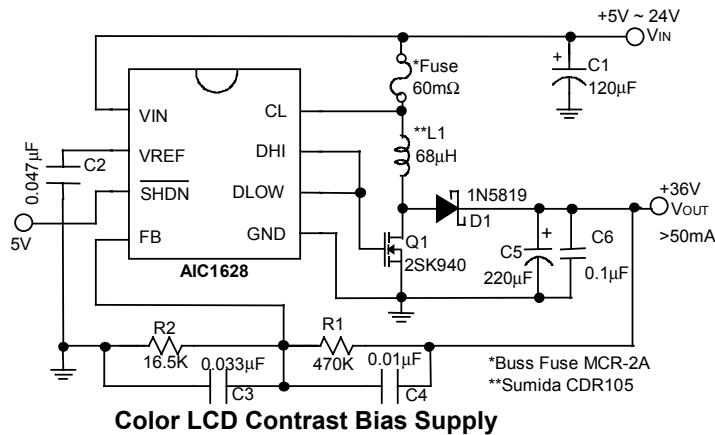
■ APPLICATIONS

- Flash Memory Programming Power Supply.
- Positive LCD Contrast Bias for Notebook & Palmtop Computers.
- Step-Up DC/DC Converter Module.
- Telecom Power Supply.

■ DESCRIPTION

The AIC1628 is a high performance step-up DC/DC converter, designed to drive an external power switch to generate programmable positive voltages. In the particularly suitable LCD contrast bias and flash memory programming power supply applications, typical full-load efficiencies are 85% to 95%. 4V to 24V input operation range allows the AIC1628 to be powered directly by the battery pack in the most battery-operated applications for greater efficiency. Output voltage can be scaled to 40V or greater by two external resistors. A Pulse-Frequency Modulation scheme is employed to maintain high efficiency conversion under wide input voltage range. Quiescent current is about 100 μ A and can be reduced to 8 μ A in shutdown mode. Switching frequency being around 90KHz to 250KHz range, small size switching components are ideal for battery powered portable equipments, like notebook and palmtop computers.

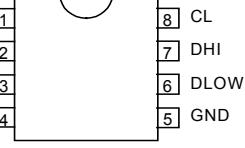
■ TYPICAL APPLICATION CIRCUIT



■ ORDERING INFORMATION

AIC1628 XX

PACKAGE TYPE
 N: PLASTIC DIP
 S: SMALL OUTLINE
 TEMPERATURE RANGE
 $C=0^{\circ}\text{C} \sim +70^{\circ}\text{C}$

ORDER NUMBER	PIN CONFIGURATION
AIC1628CN (PLASTIC DIP)	TOP VIEW 
AIC1628CS (PLASTIC SO)	

■ ABSOLUTE MAXIMUM RATINGS

VIN Supply Voltage (V _{IN} Pin)	24V
SHDN Pin Voltage	15V
Operating Temperature Range	0°C~70°C
Storage Temperature Range	-65°C~ 150°C

■ TEST CIRCUIT

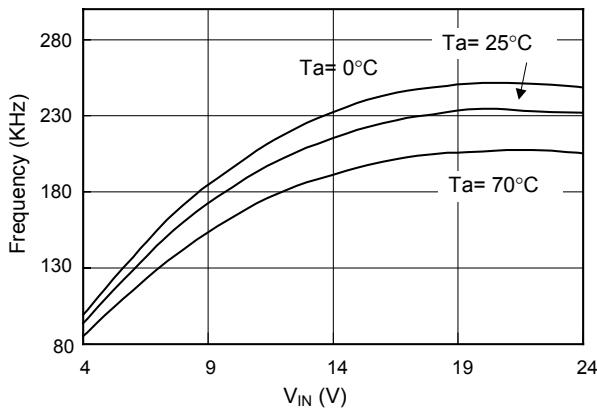
Refer to Typical Application Circuit

■ ELECTRICAL CHARACTERISTICS ($V_{IN} = 13V$, $T_a = 25^{\circ}\text{C}$, unless otherwise specified.)

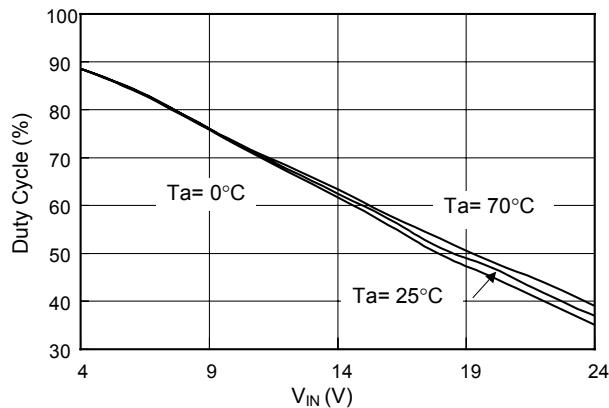
PARAMETERS	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Input Voltage		4	24		V
Quiescent Current	$V_{FB} = 1.5V$	100	200		μA
Shutdown Mode Current	$V_{SHDN} = 0V$	8	20		μA
V_{REF} Voltage	$I_{SOURCE} = 250\mu\text{A}$	1.16	1.22	1.28	V
V_{REF} Source Current		250			μA
DLOW "ON Resistance"		15			Ω
DHI "ON Resistance"		10			Ω
CL Threshold	$V_{IN} - V_{CL}$	45	60	75	mV
Shutdown Threshold		0.8	1.5	2.4	V
Shutdown Input Leakage Current	$V_{SHDN} < 15V$		1		μA

■ TYPICAL PERFORMANCE CHARACTERISTICS

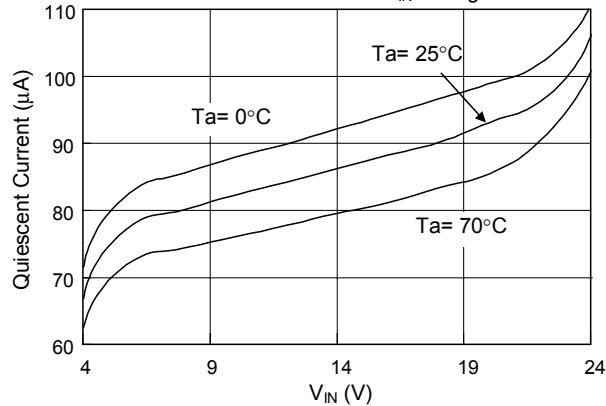
Frequency vs V_{IN} Voltage



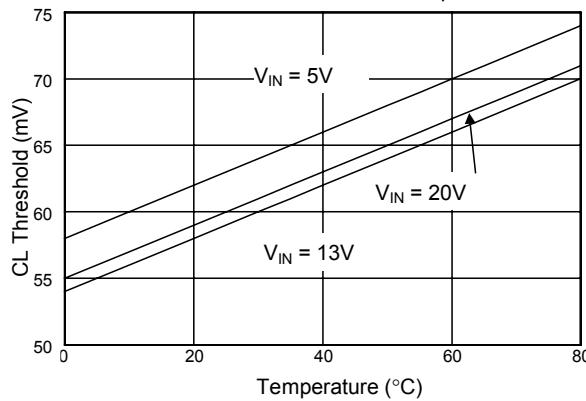
Duty Cycle vs V_{IN} Voltage



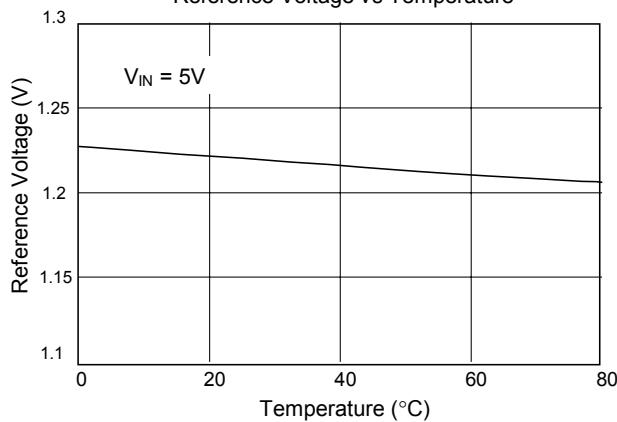
Quiescent Current vs V_{IN} Voltage



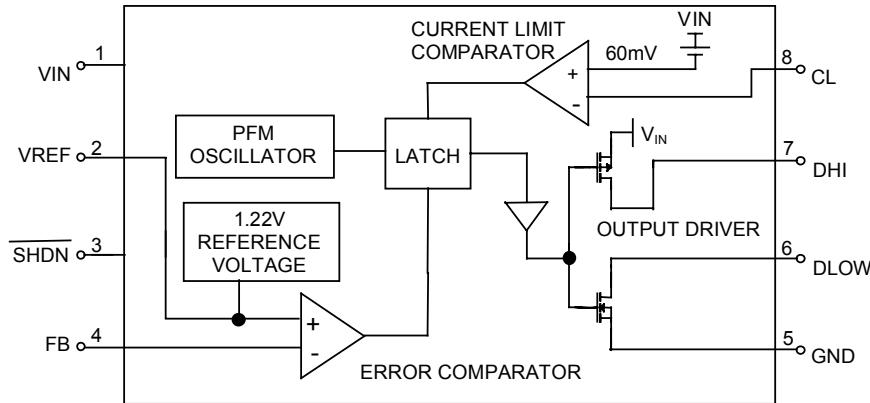
Current Limit Threshold vs Temperature



Reference Voltage vs Temperature



■ BLOCK DIAGRAM



■ PIN DESCRIPTIONS

PIN 1: VIN - 4V to 24V input supply voltage.

PIN 2: VREF - 1.22V reference output. Bypass with a 0.047 μ F capacitor to GND. Sourcing capability is guaranteed to be greater than 250 μ A.

PIN 3: SHDN - Logical input to shutdown the chip.
 >1.5V = normal operation,
 GND = Shutdown,
 Can not be floating or forced greater than 15V. In shutdown mode DLOW and DHI pins are at low level.

PIN 4: FB - Feedback signal input to sense VREF. Connecting a resistance R1 to V_{OUT} and a resistance R2 to GND yields the output voltage:
 $V_{OUT} = (R1+R2)/R2 \times VREF$
 (Refer to typical application circuit)

PIN 5: GND - Power ground.

PIN 6: DLOW -Driver sinking output. Connected to gate of the external N-channel MOSFET or base of the NPN bipolar transistor.

PIN 7: DHI - Driver sourcing output. Connected to DLOW when using an external N-channel MOSFET. When using an external NPN bipolar transistor, connect a base resistance RB from this pin to DLOW. RB value depends on V_{IN}, inductor and NPN current gain.

PIN 8: CL - Current-limit input. Threshold voltage is 60mV from V_{IN}. This pin clamps the switch peak current to prevent over-current damage to the external switch, under abnormal conditions.

■ APPLICATION EXAMPLES

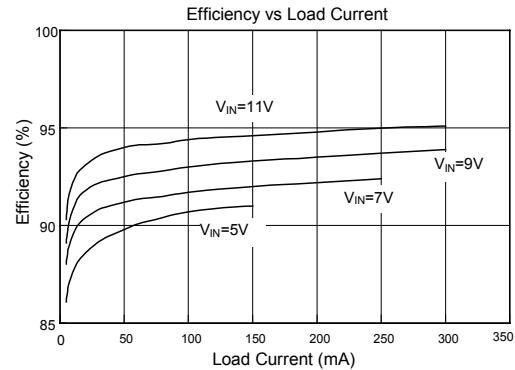
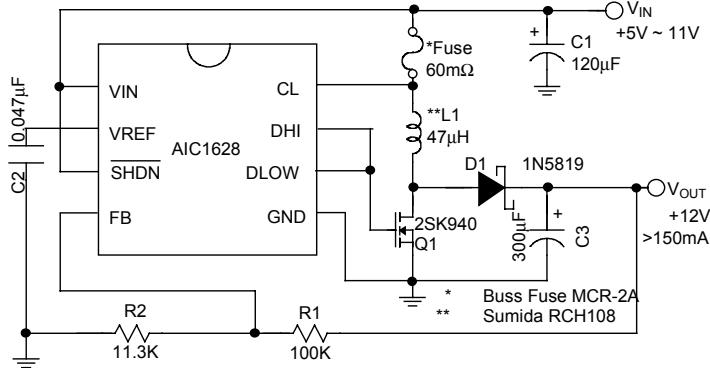


Fig. 1 Flash memory programming supply

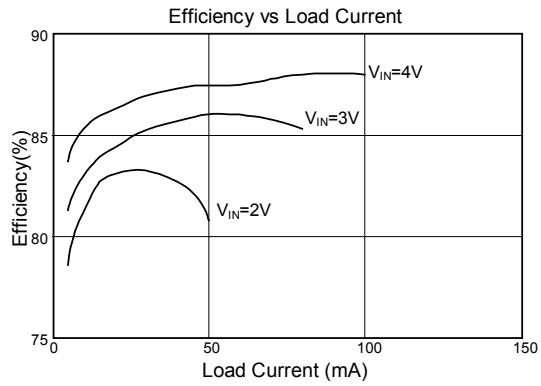
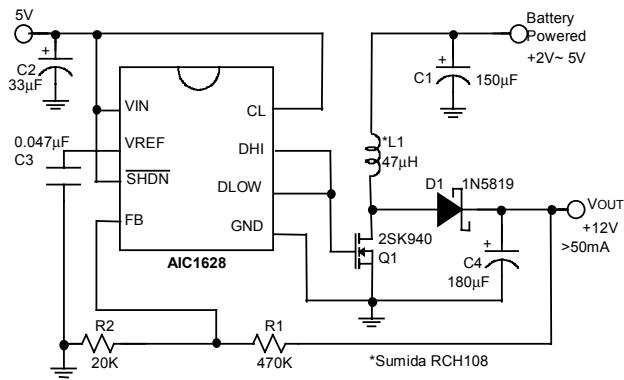


Fig. 2 2-cells to +12V Flash memory programmer

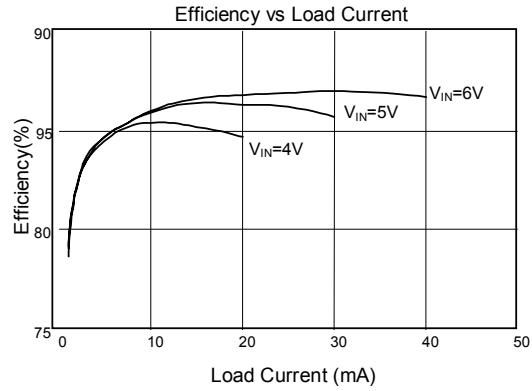
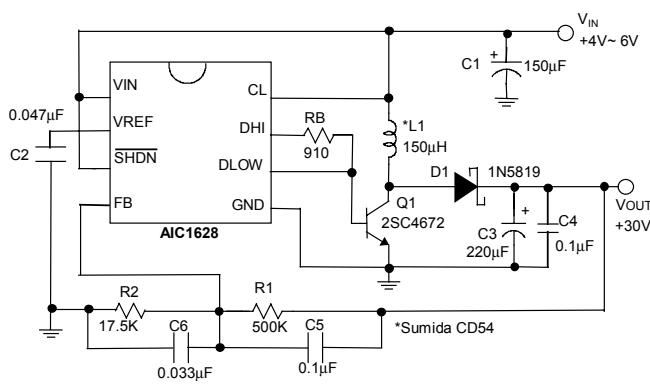


Fig. 3 4-cells to +30V power supply

■ APPLICATION EXAMPLES (CONTINUED)

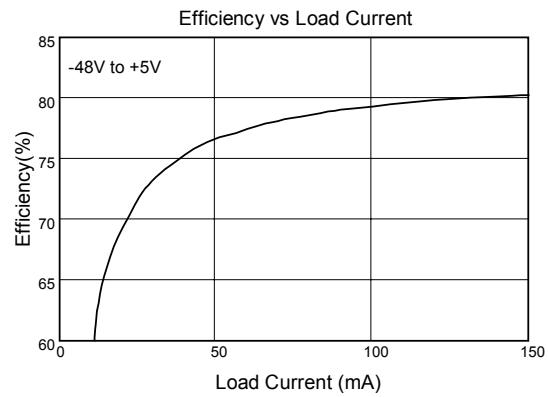
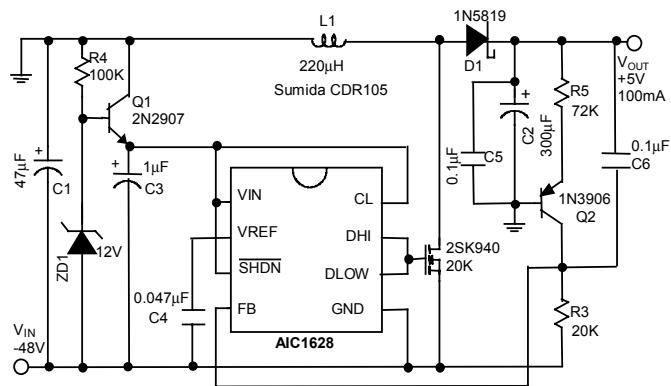


Fig. 4 Telecom +5V supply

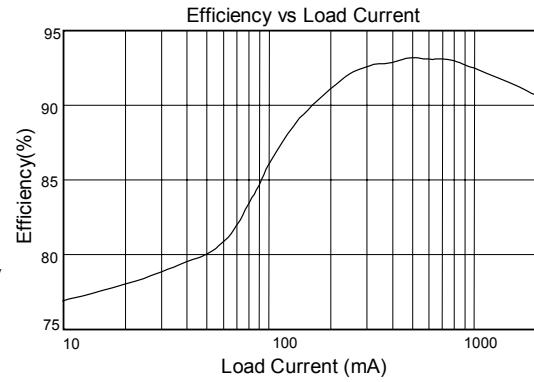
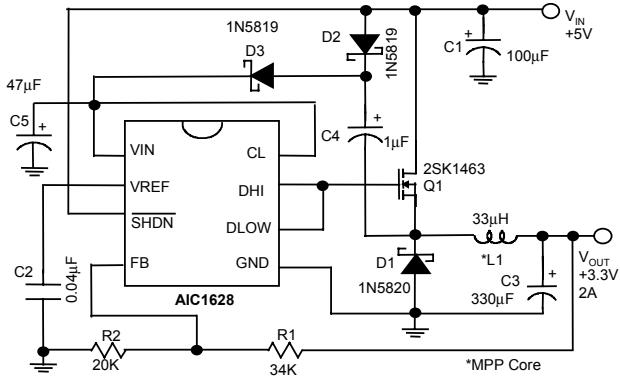
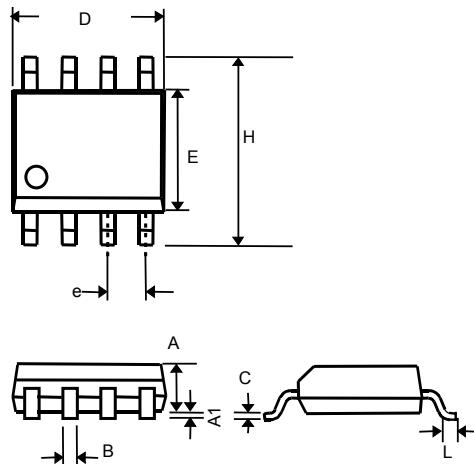


Fig. 5 5V to 3.3V step-down converter

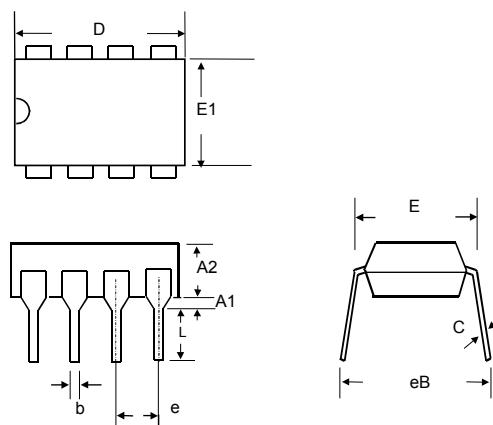
■ PHYSICAL DIMENSIONS

- 8 LEAD PLASTIC SO (unit: mm)



SYMBOL	MIN	MAX
A	1.35	1.75
A1	0.10	0.25
B	0.33	0.51
C	0.19	0.25
D	4.80	5.00
E	3.80	4.00
e	1.27(TYP)	
H	5.80	6.20
L	0.40	1.27

- 8 LEAD PLASTIC DIP (unit: mm)



SYMBOL	MIN	MAX
A1	0.381	—
A2	2.92	4.96
b	0.35	0.56
C	0.20	0.36
D	9.01	10.16
E	7.62	8.26
E1	6.09	7.12
e	2.54 (TYP)	
eB	—	10.92
L	2.92	3.81